# 2SB0953 (2SB953), 2SB0953A (2SB953A)

### Silicon PNP epitaxial planar type

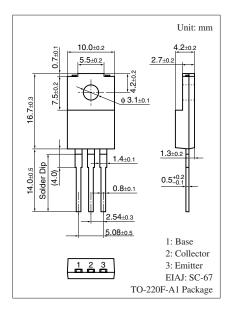
For low-voltage switching

#### Features

- $\bullet$  Low collector-emitter saturation voltage  $V_{\mbox{CE(sat)}}$
- High-speed switching
- Full-pack package which can be installed to the heat sink with one screw

#### Absolute Maximum Ratings $T_C = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Collector-base voltage	2SB0953	V <sub>CBO</sub>	-40	V
(Emitter open)	2SB0953A		-50	
Collector-emitter voltage	2SB0953	V <sub>CEO</sub>	-20	V
(Base open)	2SB0953A		-40	
Emitter-base voltage (Col	V <sub>EBO</sub>	-5	V	
Collector current	I <sub>C</sub>	-7	А	
Peak collector current	I <sub>CP</sub>	-12	А	
Collector power	P <sub>C</sub>	30	W	
dissipation	$T_a = 25^{\circ}C$		2	
Junction temperature	Tj	150	°C	
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	



#### Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

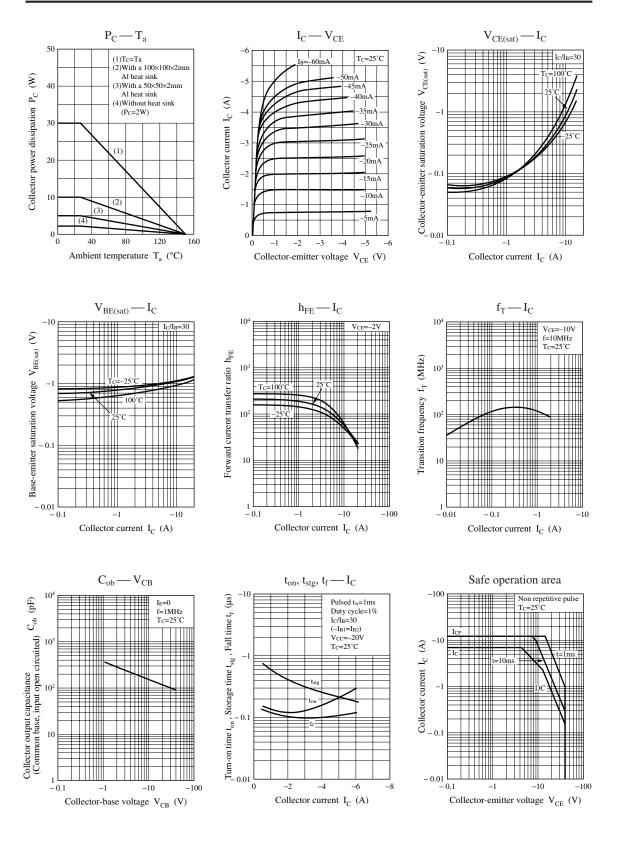
Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SB0953	V <sub>CEO</sub>	$I_{\rm C} = -10 \text{ mA}, I_{\rm B} = 0$	-20			V
(Base open)	2SB0953A			-40			
Collector-base cutoff	2SB0953	I <sub>CBO</sub>	$V_{CB} = -40 \text{ V}, I_E = 0$			-50	μΑ
current (Emitter open)	2SB0953A		$V_{CB} = -50 \text{ V}, I_E = 0$			-50	
Emitter-base cutoff current (Co	llector open)	I <sub>EBO</sub>	$V_{EB} = -5 V, I_C = 0$			-50	μΑ
Forward current transfer ratio		h <sub>FE1</sub>	$V_{CE} = -2 V, I_C = -0.1 A$	45			
		h <sub>FE2</sub> *	$V_{CE} = -2 V, I_C = -2 A$	60		260	
Collector-emitter saturation	voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = -5$ A, $I_{\rm B} = -0.16$ A			- 0.6	V
Base-emitter saturation volt	tage	V <sub>BE(sat)</sub>	$I_{\rm C} = -5 \text{ A}, I_{\rm B} = -0.16 \text{ A}$			-1.5	V
Transition frequency		f <sub>T</sub>	$V_{CE} = -10 \text{ V}, I_C = -0.5 \text{ A}, f = 10 \text{ MHz}$		150		MHz
Collector output capacitance		C <sub>ob</sub>	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		140		pF
(Common base, input open	circuited)						
Turn-on time		ton	$I_C = -2 A, I_{B1} = -66 mA, I_{B2} = 66 mA$		0.1		μs
Storage time		t <sub>stg</sub>	$V_{\rm CC} = -20 \text{ V}$		0.5		μs
Fall time		t <sub>f</sub>			0.1		μs

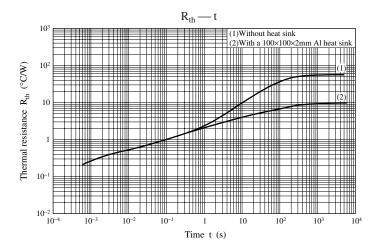
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. 2. \*: Rank classification

Rank	R	Q	Р	
h <sub>FE2</sub>	60 to 120	90 to 180	130 to 260	

Note) The part numbers in the parenthesis show conventional part number.

## Panasonic





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